Vishay Sfernice



30 W Power Resistor Thick Film Technology



LTO series are the extension of RTO types. We used the direct ceramic mounting design (no metal tab) of our RCH power resistors applied to semiconductor packages.

FEATURE

 30 W at 25 °C case temperature heatsink mounted



· Direct mounting ceramic on heatsink

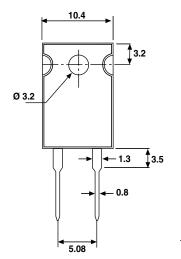
• Broad resistance range: R010 to 550K

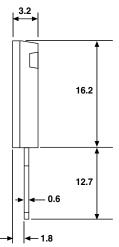
• Non inductive

• TO-220 package: Compact and easy to mount

• RoHS compliant

DIMENSIONS in millimeters





Tolerance unless otherwise specified: ± 0.3 mm

MECHANICAL SPECIFICATIONS

Mechanical ProtectionMoldedResistive ElementThick filmSubstrateAluminaConnectionsTinned copperWeight2 g max.Mounting Torqure1 Nm

DIMENSIONS

Standard Package TO-220 isolated case

ENVIRONMENTAL SPECIFICATIONS

Temperature Range Climatic Category Flammability - 55 °C to + 155 °C 55/155/56 IEC 60695-11-5 2 applications 30 s separated by 60 s

ELECTRICAL SPECIFICATIONS				
Resistance Range	$0.010~\Omega$ to $550~\text{k}\Omega$			
Tolerances (Standard)	± 1 % to ± 10 %			
Dissipation and Associated	Onto a heatsink 30 W at + 25 °C (case temp.) R _{TH} (j - c): 4.2 °C/W Free air: 2.25 W at + 25 °C See Performance table			
Power Rating and Thermal Resistance of the Component				
Temperature Coefficient				
Standard	± 150 ppm/°C			
Limiting Element Voltage U _L	250 V			
Dielectric Strength MIL STD 202	1500 V _{RMS} - 1 min 10 mA max.			
Insulation Resistance	$\geq 10^4 \text{M}\Omega$			
Inductance	≤ 0.1 μH			
Critical Resistance	2.08 kΩ			

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PERFORMANCE					
TESTS	CONDITIONS	REQUIREMENTS			
Momentary Overload	EN 60115-1 1.5 Pr/5 s <i>U</i> _S < 1.5 <i>U</i> _L	± (0.5 % + 0.005 Ω)			
Rapid Temperature Change	EN 60115-1 IEC 60068-2-14 Tests Na 5 cycles - 55 °C to + 155 °C	± (0.5 % + 0.005 Ω)			
Load Life	EN 60115-1 1000 h Pr at + 25 °C	± (1 % + 0.005 Ω)			
Humidity (Steady State)	MIL STD 202 Method 103 B Cond. D	± (0.5 % + 0.005 Ω)			
Vibration	MIL STD 202 Method 204 Cond. D	± (0.2 % + 0.005 Ω)			
Terminal Strength	MIL STD 202 Method 211 Cond. A1	± (0.2 % + 0.005 Ω)			
Shock	100G, MIL STD 202 Method 213 Cond. I	± (0.5 % + 0.005 Ω)			

SPECIAL FEATURES						
Resistance Values	≥ 0.010	≥ 0.015	≥ 0.1	≥ 0.5		
Tolerances	± 1 % at ± 10 %					
Typical Temperature Coefficient (- 55 ° to + 155 °C)	± 900 ppm/°C	± 700 ppm/°C	± 250 ppm/°C	± 150 ppm/°C		

CHOICE OF THE HEATSINK

The user must choose according to the working conditions of the component (power, room temperature). Maximum working temperature must not exceed 150 °C. The dissipated power is simply calculated by the following ratio:

$$P = \frac{\Delta T}{\left[R_{TH} (j-c) + R_{TH} (c-a)\right]}^{(1)}$$

 ΔT : Difference between maximum working temperature and room temperature

R_{TH} (j - c): Thermal resistance value measured between resistive layer and outer side of the resistor. It is the thermal resistance of the component.

R_{TH} (c - a): Thermal resistance value measured between outer side of the resistor and room temperature. It is the thermal resistance of the heatsink itself (type, shape) and the quality of the fastening device, and the thermal resistance of the thermal compound.

Example:

R_{TH} (c - a) for LTO 30 power rating 10 W at ambient temperature + 25 °C

Thermal resistance R_{TH} (j - c): 4.2 °C/W

Considering equation (1) we have:

$$\begin{split} \Delta T &= 150 \text{ °C - } 25 \text{ °C } = 125 \text{ °C} \\ R_{TH} \left(j - c \right) + R_{TH} \left(c - a \right) = \frac{\Delta T}{P} = \frac{125}{10} = 12.5 \text{ °C/W} \\ R_{TH} \left(c - a \right) &= 12.5 \text{ °C/W - } 4.2 \text{ °C/W } = 8.3 \text{ °C/W} \end{split}$$

with a thermal grease R_{TH} (c - h) = 1 °C/W, we need a heatsink with R_{TH} (h - a) = 7.3 °C/W.



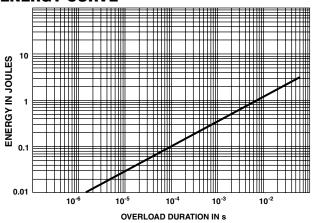
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OVERLOADS

In any case the applied voltage must be lower than the maximum overload voltage of 375 V.

The values indicated on the graph below are applicable to resistors in air or mounted onto a heatsink.

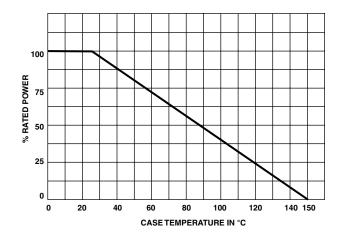
ENERGY CURVE



POWER RATING CHART

The temperature of the case should be maintained within the limits specified.

To improve the thermal conductivity, surfaces in contact should be coated with a silicone grease and the torque applied on the screw for tightening should be around 1 Nm.

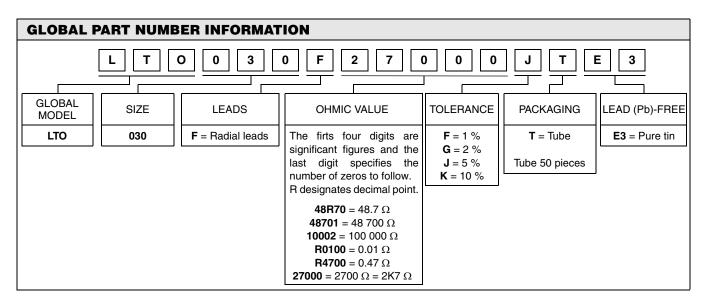


MARKING

Model, style, resistance value (in Ω), tolerance (in %), manufacturing date, VISHAY trademark.

PACKAGING	
Tube of 50 units	

ORDERING INFORMATION							
LTO	30	F	2.7 $\mathbf{k}\Omega$	± 1 %	xxx	TU50	e3
MODEL	STYLE	CONNECTIONS	RESISTANCEVALUE	TOLERANCE	CUSTOM DESIGN	PACKAGING	LEAD (Pb)-FREE
				± 1 % ± 2 % ± 5 % ± 10 %	Optional on request: Special TCR, shape etc.		



Document Number: 50049 Revision: 16-Oct-08



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Revision: 18-Jul-08

Document Number: 91000